

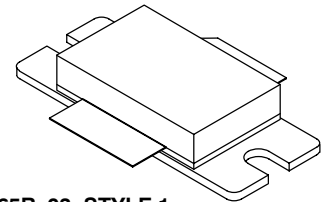
The RF Sub-Micron MOSFET Line
RF Power Field Effect Transistors
N-Channel Enhancement-Mode Lateral MOSFETs

MRF21125R3
MRF21125SR3

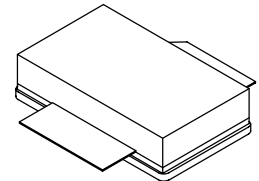
Designed for W-CDMA base station applications with frequencies from 2110 to 2170 MHz. Suitable for TDMA, CDMA and multicarrier amplifier applications. To be used in Class AB for PCN - PCS/cellular radio and WLL applications.

2170 MHz, 125 W, 28 V
LATERAL N-CHANNEL
RF POWER MOSFETs

- Typical 2-carrier W-CDMA Performance for $V_{DD} = 28$ Volts, $I_{DQ} = 1600$ mA, $f_1 = 2.1125$ GHz, $f_2 = 2.1225$ GHz, Channel bandwidth = 3.84 MHz, adjacent channels at ± 5 MHz, ACPR and IM3 measured in 3.84 MHz bandwidth. Peak/Avg = 8.5 dB @ 0.01% probability on CCDF.
 - Output Power — 20 Watts
 - Efficiency — 18%
 - Gain — 13 dB
 - IM3 — -43 dBc
 - ACPR — -45 dBc
- 100% Tested under 2-carrier W-CDMA
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 28 Vdc, 2170 MHz, 125 Watts (CW) Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel.



CASE 465B-03, STYLE 1
NI-880
MRF21125R3



CASE 465C-02, STYLE 1
NI-880S
MRF21125SR3

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	Vdc
Gate-Source Voltage	V_{GS}	-0.5, +15	Vdc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	330 1.89	Watts W/ $^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	200	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value (1)	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.53	$^\circ\text{C/W}$

(1) Refer to AN1955/D, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.motorola.com/semiconductors/rf>. Select Documentation/Application Notes - AN1955.

NOTE - CAUTION - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-Source Breakdown Voltage (V _{GS} = 0 Vdc, I _D = 100 μA)	V _{(BR)DSS}	65	—	—	Vdc
Gate-Source Leakage Current (V _{GS} = 5 Vdc, V _{DS} = 0 Vdc)	I _{GSS}	—	—	1	μA
Zero Gate Voltage Drain Leakage Current (V _{DS} = 28 Vdc, V _{GS} = 0 Vdc)	I _{DSS}	—	—	10	μA

ON CHARACTERISTICS

Forward Transconductance (V _{DS} = 10 Vdc, I _D = 3 Adc)	g _{fs}	—	10.8	—	S
Gate Threshold Voltage (V _{DS} = 10 V, I _D = 300 μA)	V _{GS(th)}	2	—	4	Vdc
Gate Quiescent Voltage (V _{DS} = 28 V, I _D = 1300 mA)	V _{GS(Q)}	2.5	3.9	4.5	Vdc
Drain-Source On-Voltage (V _{GS} = 10 V, I _D = 1 A)	V _{DS(on)}	—	0.12	—	Vdc

DYNAMIC CHARACTERISTICS

Reverse Transfer Capacitance (1) (V _{DS} = 28 Vdc, V _{GS} = 0, f = 1 MHz)	C _{rss}	—	5.4	—	pF
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FUNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system) 2-carrier W-CDMA, 3.84 MHz Channel Bandwidth, IM3 measured in 3.84 MHz Bandwidth. Peak/Avg = 8.5 dB @ 0.01% probability on CCDF.

Common-Source Amplifier Power Gain (V _{DD} = 28 Vdc, P _{out} = 20 W Avg, 2-carrier W-CDMA, I _{DQ} = 1600 mA, f ₁ = 2112.5 MHz, f ₂ = 2122.5 MHz and f ₁ = 2157.5 MHz, f ₂ = 2167.5 MHz)	G _{ps}	12	13	—	dB
Drain Efficiency (V _{DD} = 28 Vdc, P _{out} = 20 W Avg, 2-carrier W-CDMA, I _{DQ} = 1600 mA, f ₁ = 2112.5 MHz, f ₂ = 2122.5 MHz and f ₁ = 2157.5 MHz, f ₂ = 2167.5 MHz)	η	17	18	—	%
Third Order Intermodulation Distortion (V _{DD} = 28 Vdc, P _{out} = 20 W Avg, 2-carrier W-CDMA, I _{DQ} = 1600 mA, f ₁ = 2112.5 MHz, f ₂ = 2122.5 MHz and f ₁ = 2157.5 MHz, f ₂ = 2167.5 MHz; IM3 measured at f ₁ -10 MHz and f ₂ +10 MHz referenced to carrier channel power.)	IM3	—	-43	-40	dBc
Adjacent Channel Power Ratio (V _{DD} = 28 Vdc, P _{out} = 20 W Avg, 2-carrier W-CDMA, I _{DQ} = 1600 mA, f ₁ = 2112.5 MHz, f ₂ = 2122.5 MHz and f ₁ = 2157.5 MHz, f ₂ = 2167.5 MHz; ACPR measured at f ₁ -5 MHz and f ₂ +5 MHz referenced to carrier channel power.)	ACPR	—	-45	-40	dBc
Input Return Loss (V _{DD} = 28 Vdc, P _{out} = 20 W Avg, 2-carrier W-CDMA, I _{DQ} = 1600 mA, f ₁ = 2112.5 MHz, f ₂ = 2122.5 MHz and f ₁ = 2157.5 MHz, f ₂ = 2167.5 MHz)	IRL	—	-12	-9.0	dB
Output Mismatch Stress (V _{DD} = 28 Vdc, P _{out} = 125 W CW, I _{DQ} = 1600 mA, f = 2170 MHz, VSWR = 5:1, All Phase Angles at Frequency of Test)	Ψ	No Degradation In Output Power Before and After Test			

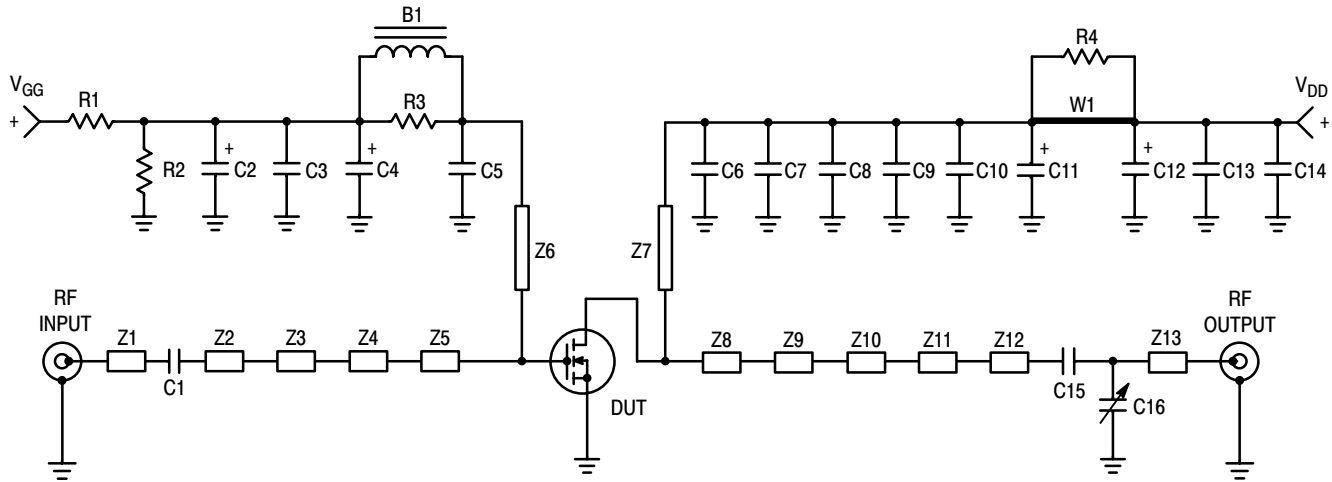
(1) Part is internally matched both on input and output.

(continued)

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ELECTRICAL CHARACTERISTICS — continued ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
TYPICAL TWO-TONE PERFORMANCE (In Motorola Test Fixture)					
Common-Source Amplifier Power Gain ($V_{DD} = 28\text{ Vdc}$, $P_{out} = 125\text{ W PEP}$, $I_{DQ} = 1600\text{ mA}$, $f_1 = 2110\text{ MHz}$, $f_2 = 2120\text{ MHz}$ and $f_1 = 2160\text{ MHz}$, $f_2 = 2170\text{ MHz}$)	G_{ps}	—	12	—	dB
Drain Efficiency ($V_{DD} = 28\text{ Vdc}$, $P_{out} = 125\text{ W PEP}$, $I_{DQ} = 1600\text{ mA}$, $f_1 = 2110\text{ MHz}$, $f_2 = 2120\text{ MHz}$ and $f_1 = 2160\text{ MHz}$, $f_2 = 2170\text{ MHz}$)	η	—	34	—	%
Intermodulation Distortion ($V_{DD} = 28\text{ Vdc}$, $P_{out} = 125\text{ W PEP}$, $I_{DQ} = 1600\text{ mA}$, $f_1 = 2110\text{ MHz}$, $f_2 = 2120\text{ MHz}$ and $f_1 = 2160\text{ MHz}$, $f_2 = 2170\text{ MHz}$)	IMD	—	-30	—	dBc
TYPICAL CW PERFORMANCE					
Common-Source Amplifier Power Gain ($V_{DD} = 28\text{ Vdc}$, $P_{out} = 125\text{ W CW}$, $I_{DQ} = 1600\text{ mA}$, $f = 2170.0\text{ MHz}$)	G_{ps}	—	11.5	—	dB
Drain Efficiency ($V_{DD} = 28\text{ Vdc}$, $P_{out} = 125\text{ W CW}$, $I_{DQ} = 1600\text{ mA}$, $f = 2170.0\text{ MHz}$)	η	—	46	—	%



Z1	1.212" x 0.082" Microstrip	Z8	0.600" x 1.056" Microstrip
Z2	0.236" x 0.082" Microstrip	Z9	0.179" x 0.219" Microstrip
Z3	0.086" x 0.254" Microstrip	Z10	0.100" x 0.336" Microstrip
Z4	0.357" x 0.082" Microstrip	Z11	0.534" x 0.142" Microstrip
Z5	0.274" x 1.030" Microstrip	Z12	0.089" x 0.080" Microstrip
Z6	0.466" x 0.050" Microstrip	Z13	0.620" x 0.080" Microstrip
Z7	0.501" x 0.050" Microstrip	PCB	Arlon GX0300-55-22, 0.030", $\epsilon_r = 2.55$

Figure 1. MRF21125 Test Circuit Schematic

Table 1. MRF21125 Test Circuit Component Designations and Values

Designators	Description
B1	Ferrite Bead (Square), Fair Rite #2743019447
C1	9.1 pF Chip Capacitor, B Case, ATC #100B9R1CCA500X
C2, C4, C11, C12	22 μ F, 35 V Tantalum Surface Mount Chip Capacitors, Kemet #T491X226K035AS4394
C3, C7	20000 pF Chip Capacitors, B Case, ATC #100B203JCA50X
C5, C14	5.1 pF Chip Capacitors, B Case, ATC #100B5R1CCA500X
C6	100000 pF Chip Capacitor, B Case, ATC #100B104JCA50X
C8	10000 pF Chip Capacitor, B Case, ATC #100B103JCA50X
C9	7.5 pF Chip Capacitor, B Case, ATC #100B7R5CCA500X
C10	1.2 pF Chip Capacitor, B Case, ATC #100B1R2CCA500X
C13	0.1 μ F Chip Capacitor, Kemet #CDR33BX104AKWS
C15	16 pF Chip Capacitor, B Case, ATC #100B160KP500X
C16	0.6 - 4.5 pF Variable Capacitor, Johanson Gigatrim #27271SL
R1	1.0 k Ω , 1/8 W Chip Resistor
R2	560 k Ω , 1/8 W Chip Resistor
R3	4.7 Ω , 1/8 W Chip Resistor
R4	12 Ω , 1/8 W Chip Resistor
W1	Solid Copper Buss Wire, 16 AWG

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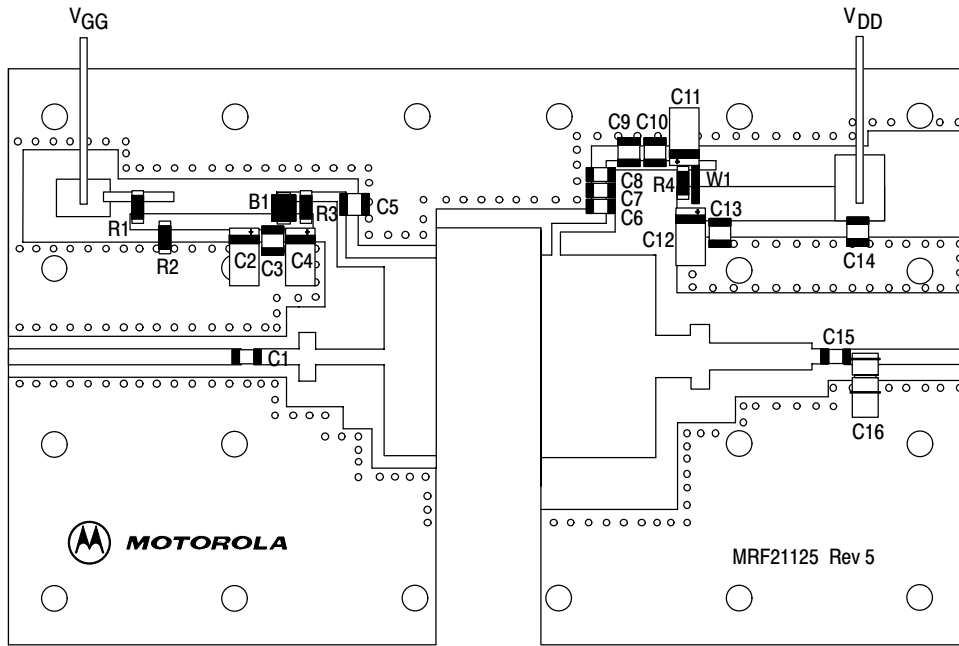


Figure 2. MRF21125 Test Circuit Component Layout

TYPICAL CHARACTERISTICS

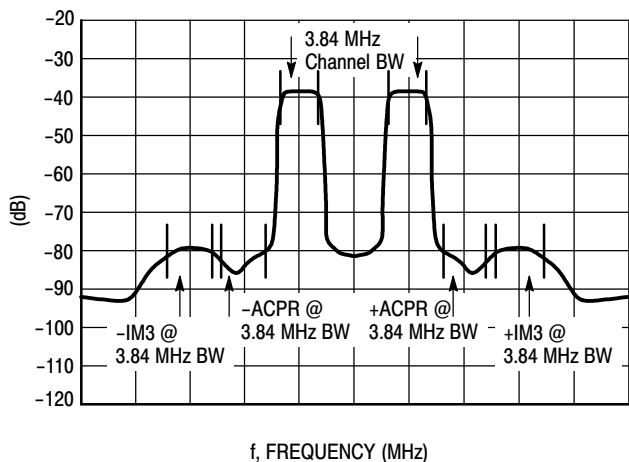


Figure 3. 2-Carrier (10 MHz Spacing) W-CDMA Spectrum

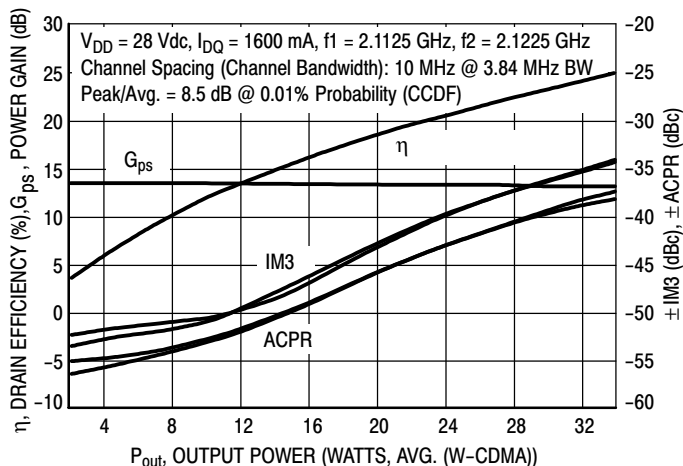


Figure 4. 2-Carrier W-CDMA ACPR, IM3, Power Gain and Drain Efficiency versus Output Power

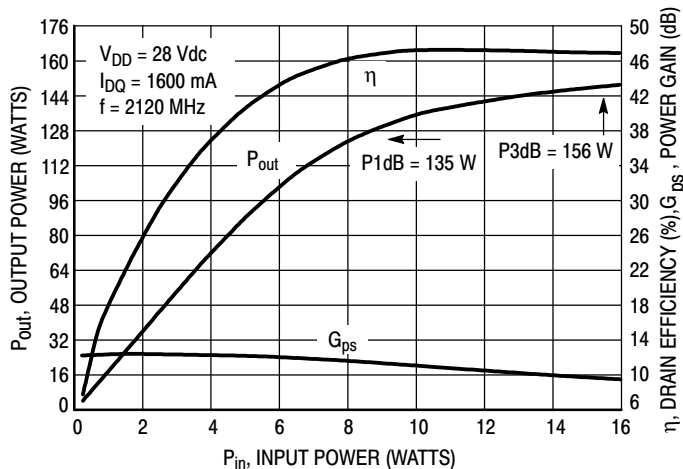


Figure 5. CW Performance

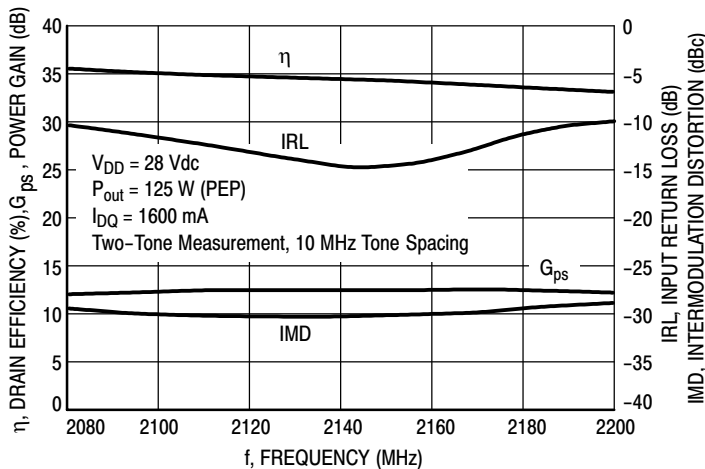


Figure 6. Broadband Linearity Performance

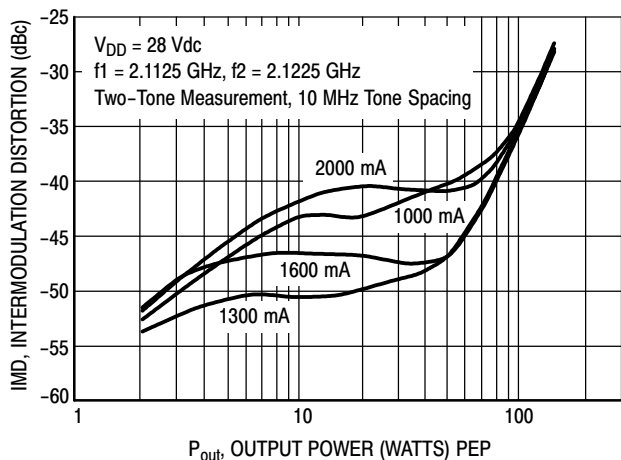


Figure 7. Intermodulation Distortion versus Output Power

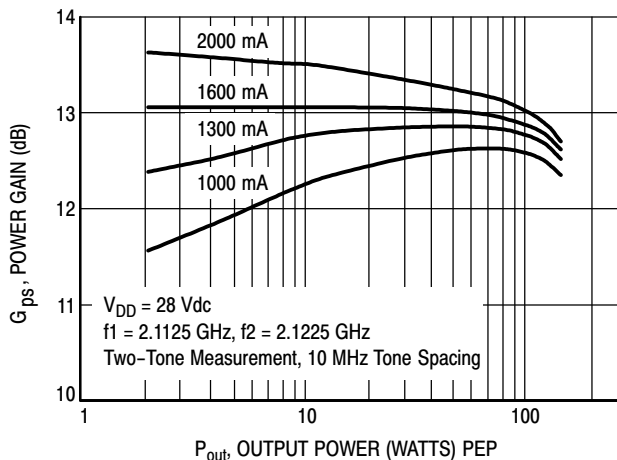
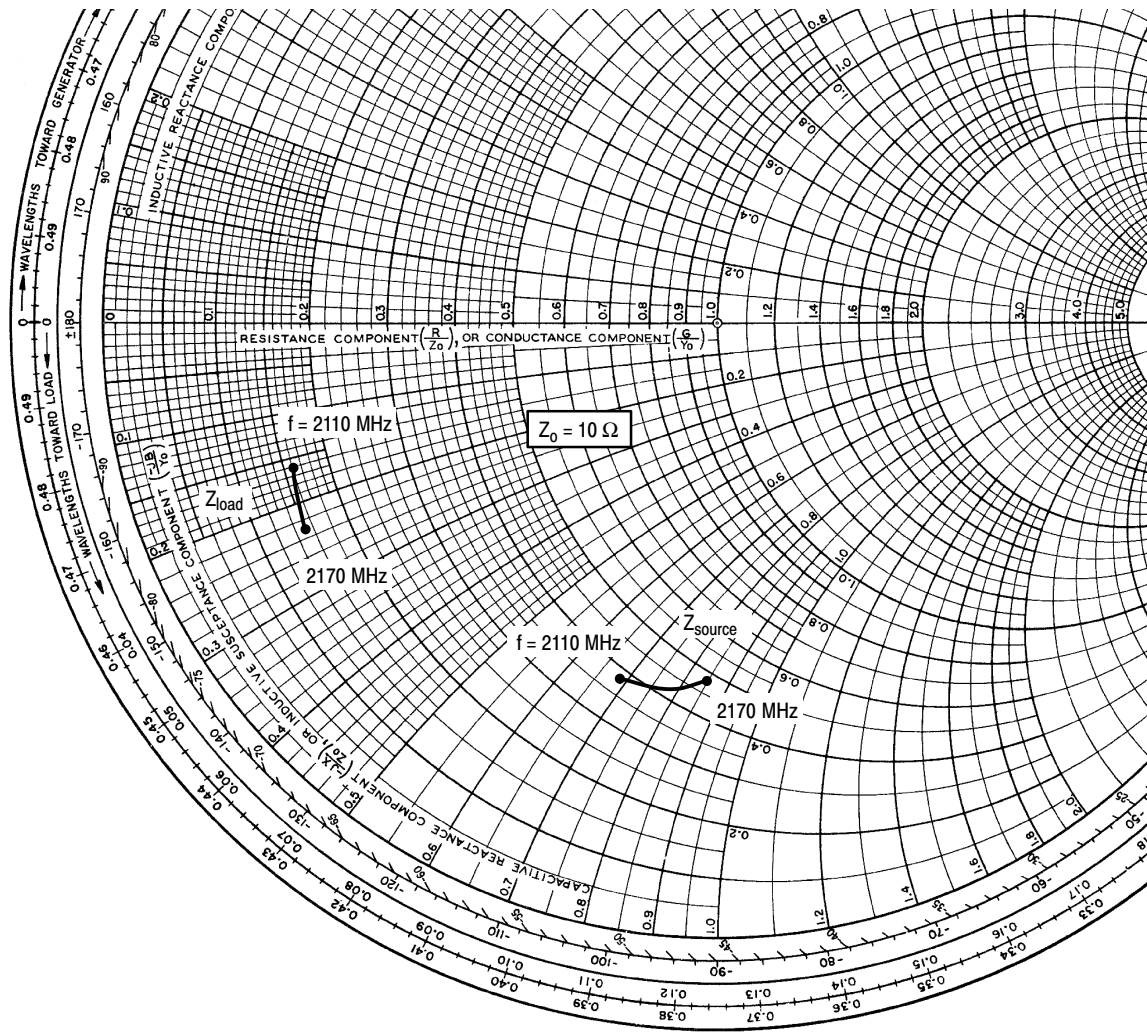


Figure 8. Power Gain versus Output Power



$V_{DD} = 28\text{ V}$, $I_{DQ} = 1600\text{ mA}$, $P_{out} = 20\text{ W (Avg.)}$, 2-Carrier W-CDMA

f MHz	Z_{source} Ω	Z_{load} Ω
2110	$3.81 - j6.86$	$1.56 - j1.58$
2140	$4.33 - j7.90$	$1.53 - j1.90$
2170	$4.84 - j8.46$	$1.48 - j2.26$

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

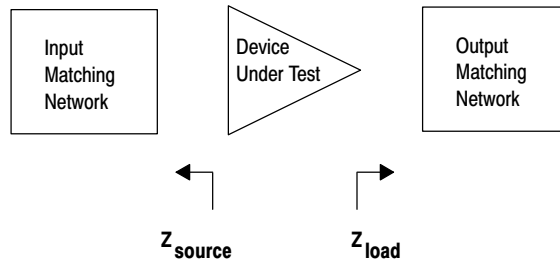


Figure 9. Series Equivalent Input and Output Impedance

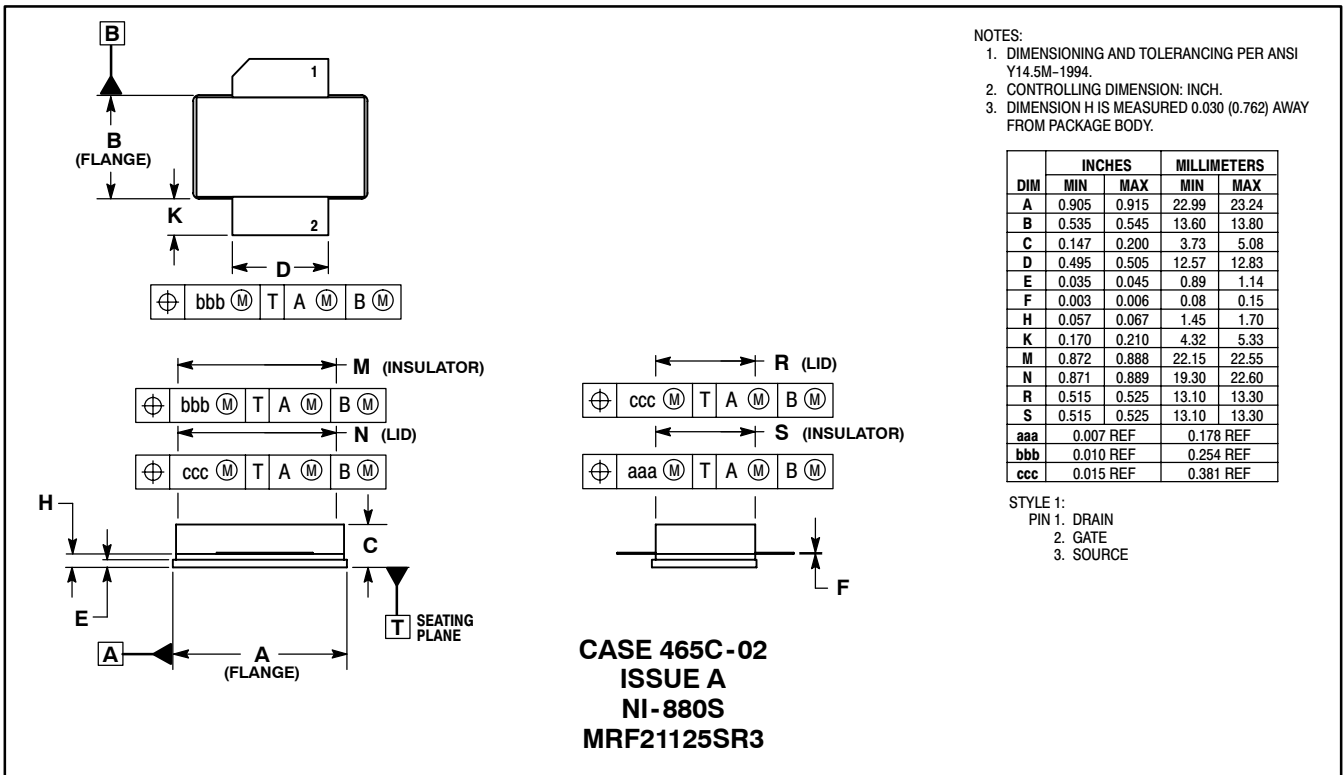
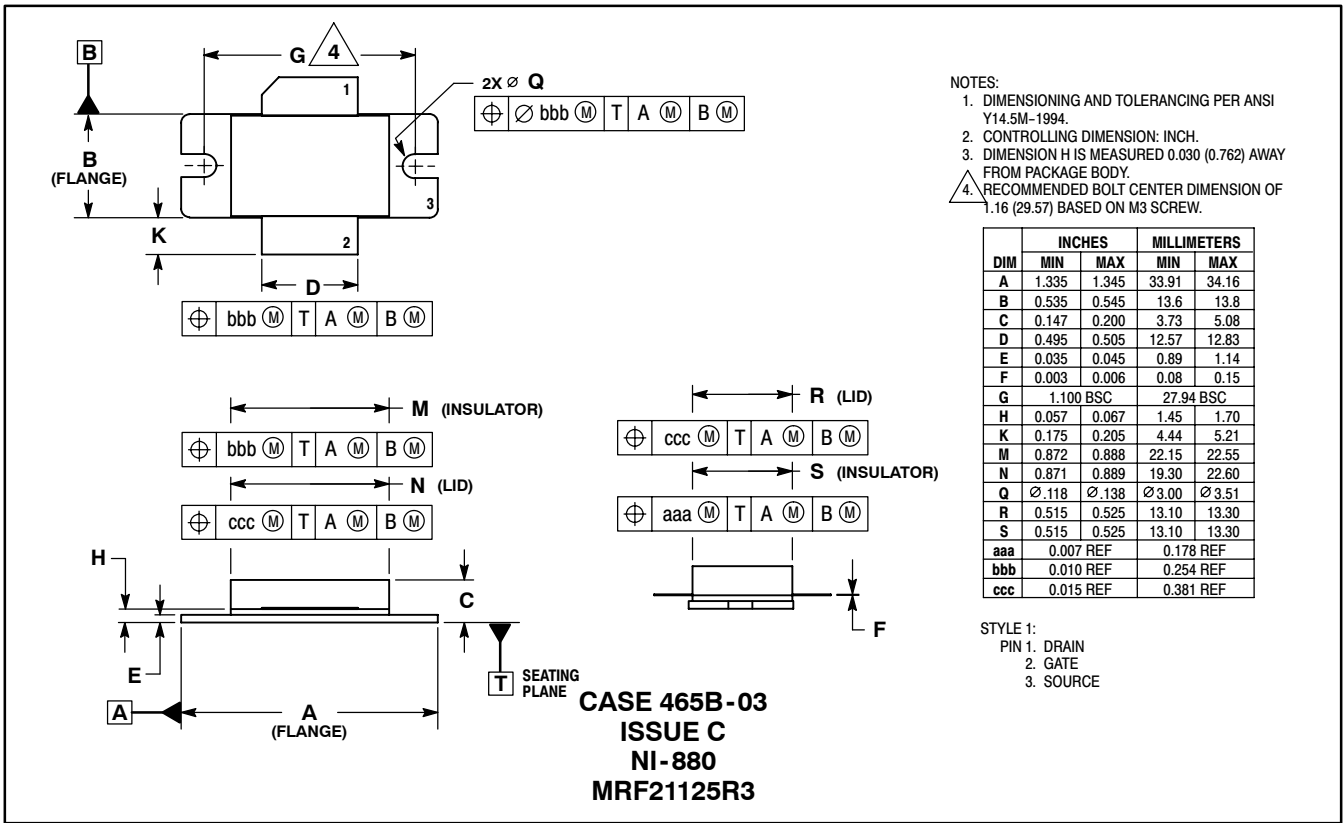
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